

TOL-C9EUB6D

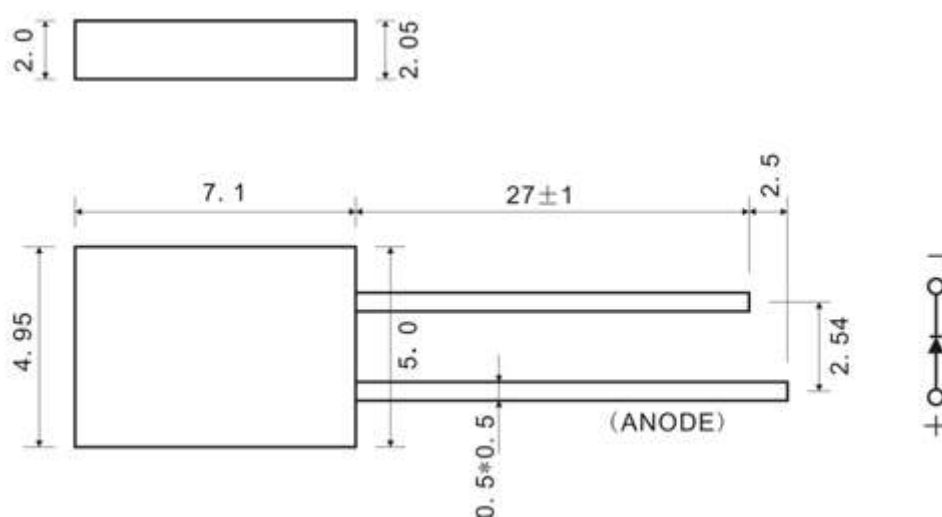
Lamp LED

Part Number	Chip		Lens Color
	Material	Source Color	
TOL-C9EUB6D	InGaN	Blue	Blue Diffused

Features

- I.C. compatible.
- Low power consumption.
- Compatible with wave soldering process.
- (2mm*5mm*7mm) rectangular package..
- Long life, stable and reliable.
- RoHS compliant.

Dimensions



Notes:

1. All dimensions are in millimeter.
2. Tolerance is ± 0.25 mm unless otherwise noted.

Absolute Maximum Rating @ Ta=25°C

Parameter	Maximum Rating	Unit
Power Dissipation (Tamb ≤ 60°C)	100	mW
Continuous Forward Current	30	mA
Reverse Voltage	5	V
Operating Temperature Range	-40°C to +80°C	
Storage Temperature Range	-40°C to +100°C	
Wave Soldering Profile For Lead-free Soldering	260°C for 5 Sec	

Electrical / Optical Characteristic @ Ta=25°C

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity	Iv	83	-	252	mcd	I _F =20mA
Viewing Angle	2θ _{1/2}	-	150	-	deg	I _F =20mA
Dominant Wavelength	λ _d	464	-	474	nm	I _F =20mA
Spectral Line Half-Width	Δλ		25		nm	I _F =20mA
Forward Voltage	V _F	2.8	-	3.6	V	I _F =20mA
Reverse Current	I _R	-	-	10	μA	V _R =5V

* Please refer to CIE 1931 chromaticity diagram.

Bin Code List for Reference

Luminous Intensity		Unit : mcd@20mA
Bin Code	Min	Max
B29	83	103
B30	103	129
B31	129	162
B32	162	202
B33	202	252

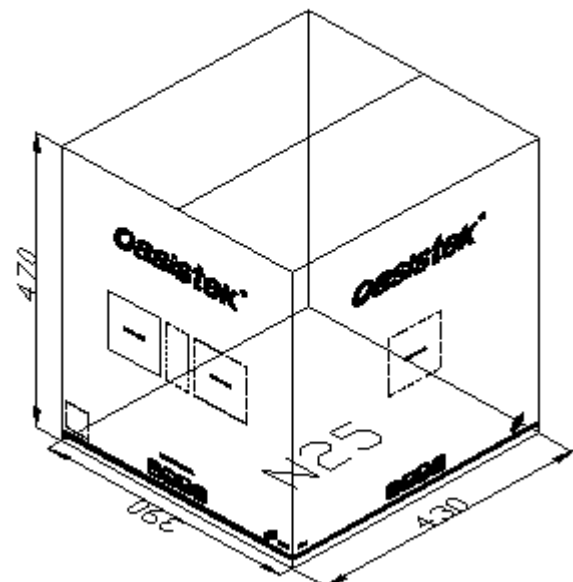
Tolerance of Luminous Intensity on each bin is $\pm 15\%$.

Dominant Wavelength		Unit : nm@20mA
Bin Code	Min	Max
23	464	466
24	466	468
25	468	470
26	470	472
27	472	474

Tolerance of Dominant Wavelength on each bin is $\pm 1\text{nm}$.

Forward Voltage		Unit : VF@20mA
Bin Code	Min	Max
V10	2.8	3.0
V11	3.0	3.2
V12	3.2	3.4
V13	3.4	3.6

Tolerance of Forward Voltage on each bin is $\pm 0.1\text{V}$.



Reliability Test Project

Description	Item	Test criterion	Test condition	Test time	Qty	Fail Qty
Life test	Life test (Room temperature)	JIS7021:B4	Ta=25°C±5°C, IF=20mA	1000 Hrs	20	0
Ambience test	High temperature store	JIS7021:B10 MIL-STD-202:210A MIL-STD-750:2031	Ta=85°C±5°C	1000 Hrs	20	0
	Low temperature store	JIS7021:B12	Ta= -35°C±5°C	1000 Hrs	20	0
	High temperature/ humidity test	JIS7021:B11 MIL-STD-202:103D	Ta=85°C±5°C RH=85%	1000 Hrs	20	0
	Cold / Heat strike test	JIS7021::B4 MIL-STD-202:107D MIL-STD-750:1026	30min -10°C±5°C ↔ 85°C±5°C 5min 5min	50 Cycles	20	0
	Cold and heat cycle test	JIS7021:A3 MIL-STD-202:107D MIL-STD-705:105E	5min 5min 5min -35°C ~ 25°C ~ 85°C ~ -35°C 30min 5min 30min 5min	50 Cycles	20	0

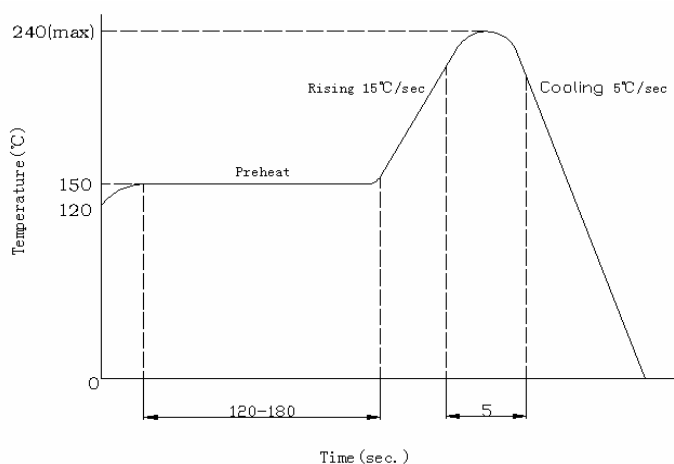
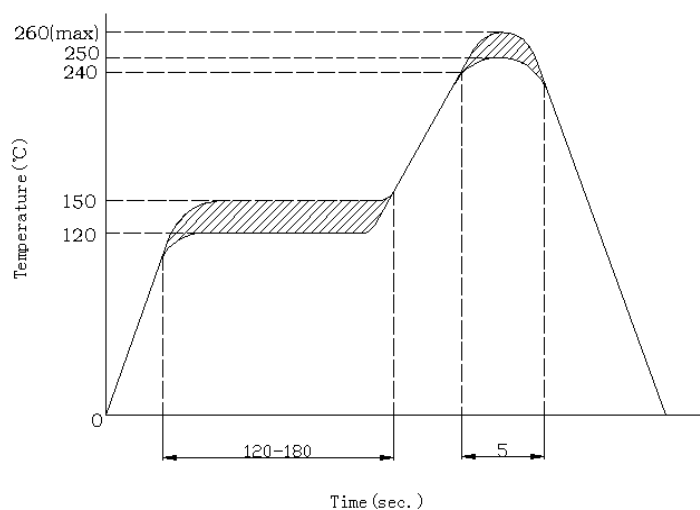
Judging criterion

Item	Symbol	Experiment condition	Criteria	
			Min.	Max.
Forward Voltage	VF	IF=20mA	-	Initial Datex1.1
Reverse Current	IR	VR=5V	-	30μA
Luminous Intensity	IV	IF=20mA	Initial Datex0.7	-

Cautions

- LED bracket forming method :
 1. The pin of led can be bent where is at least 3mm out of led colloid.
 2. Must use fixture to deform the led bracket.
 3. Finishing the forming of led bracket must be before soldering.
 4. Guarantee the gap between two pin of led tallys with LED pads in PCB when forming.
- Manual soldering :

The tip temperature of soldering iron don't exceed 260°C ; soldering time don't exceed 3s and soldering position must be 3mm out of led colloid.
- Soldering temperature curve chart (figure A、figure B) :



- ESD countermeasure

Static electricity and high volt can damage led. The production whose Die material is InGaN must strictly required to prevent ESD, must put on static glove and static fillet. Soldering tool and the cover of device must connect the ground, soldering condition follows the related stating of production specification manual.

- Protecting countermeasure when over current

Need add the protecting resistor in circuit in order to avoid damaging led due to big current and voltage fluctuation.

- LED installation method

1. Pay attention to the led polarity and avoid installation wrong. LED can't be close to eutermic component, work condition should tally with it's specification.
2. Don't install the LED under the condition of the led pin deformation.
3. The led bracket don't load any pressure when installing the led into PCB or fitting hole.
4. Must avoid any strike and force on led before the soldering temperature return to room temperature.

- Storage time

1. LED can be stored for a year under the condition:

the temperature of $5^{\circ}\text{C} \sim 35^{\circ}\text{C}$ and humidity of RH60%, These production must be re-inspected and tested before use if their storage time exceed a year.

2. If LED is exposed in air for a week under the condition:

the temperature of $5^{\circ}\text{C} \sim 35^{\circ}\text{C}$, humidity of RH60%, must place the led in the ambience of $65^{\circ}\text{C} \pm 5^{\circ}\text{C}$ for 24 hours and use it in 15 days for best.

- Cleaning

Be careful of some chemical results in the led colloid fades and damage when using chemical clean the LED such as chloroethylene, acetone etc. can use ethanol to wash or soak LED but the time don't exceed 3 minutes.

- Kinked

The kinked tooling scrape easily the pin of LED, where the led bracket is rusting easily, especial expose it in moist air. To decrease the led bracket rust, suggest using plated tin led bracket.